

# Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET** 

# **Super J-MOS series**

# N-Channel enhancement mode power MOSFET

## Features

Pb-free lead terminal **RoHS** compliant

Applications For switching





# Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

| Parameter  | Symbol               | Characteristics | Unit  | Remarks                |
|--|----------------------|-----------------|-------|------------------------|
| Drain Source Voltage                                       | VDS                  | 600             | V     |                        |
| Drain-Source Voltage                                       | VDSX                 | 600             | V     | V <sub>GS</sub> =-30V  |
| Continuous Drain Current                                   |                      | ±20             | А     | Tc=25°C Note*1         |
|  | ID                   | ±12.6           | А     | Tc=100°C Note*1        |
| Pulsed Drain Current                                       | IDP                  | ±60             | А     | Note*1                 |
| Gate-Source Voltage  | V <sub>GS</sub>      | ±30             | V     |                        |
| Repetitive and Non-Repetitive<br>Maximum Avalanche Current | lar                  | 6.6             | А     | Note *2                |
| Non-Repetitive<br>Maximum Avalanche Energy                 | Eas                  | 472.2           | mJ    | Note *3                |
| Maximum Drain-Source dV/dt                                 | dV <sub>DS</sub> /dt | 50              | kV/µs | V <sub>DS</sub> ≤ 600V |
| Peak Diode Recovery dV/dt                                  | dV/dt                | 30              | kV/µs | Note *4                |
| Peak Diode Recovery -di/dt                                 | -di/dt               | 100             | A/µs  | Note *5                |
| Maximum Bower Dissinction                                  | P                    | 2.02            | W     | T₂=25°C                |
| Maximum Power Dissipation                                  |                      | 150             | vv    | Tc=25°C                |
| Operating and Storage Temperature range                    | Tch                  | 150             | °C    |                        |
| Operating and Storage Temperature range                    | Tstg                 | -55 to +150     | °C    |                        |

Note \*1 : Limited by maximum channel temperature. Note \*2 : Tch ≤ 150°C, See Fig.1 and Fig.2 Note \*3 : Starting Tch=25°C, IAs=2A, L=216mH, Voo=60V, Rg=50Ω, See Fig.1 and Fig.2

EAs limited by maximum channel temperature and avalanche current. Note \*4 : Ir ≤ -ID, -di/dt=100A/µs, VDs peak ≤ 600V, Tch ≤ 150°C.

Note \*5 : IF  $\leq$  -ID, dV/dt=30kV/µs, VDs peak  $\leq$  600V, T<sub>ch</sub>  $\leq$  150°C.

#### Electrical Characteristics at T<sub>c</sub>=25°C (unless otherwise specified) Static Ratings

| Parameter                        | Symbol              | Conditions                                     |                        | min. | typ.  | max. | Unit |
|----------------------------------|---------------------|--|------------------------|------|-------|------|------|
| Drain-Source Breakdown Voltage   | BV <sub>DSS</sub>   | I₀=250µA<br>V₀s=0V                             |                        | 600  | -     | -    | V    |
| Gate Threshold Voltage           | V <sub>GS(th)</sub> | I₀=250µA<br>V₀s=V₀s                            |                        | 3    | 4     | 5    | V    |
| Zero Gate Voltage Drain Current  | loss                | V <sub>DS</sub> =600V<br>V <sub>GS</sub> =0V   | T <sub>ch</sub> =25°C  | -    | -     | 25   | -μA  |
|                                  |                     | V <sub>DS</sub> =480V<br>V <sub>GS</sub> =0V   | T <sub>ch</sub> =125°C | -    | 100   | -    |      |
| Gate-Source Leakage Current      | IGSS                | V <sub>GS</sub> = ± 30V<br>V <sub>DS</sub> =0V |                        | -    | 10    | 100  | nA   |
| Drain-Source On-State Resistance | R <sub>DS(on)</sub> | I₀=10A<br>V₀s=10V                              |                        | -    | 0.168 | 0.2  | Ω    |
| Gate resistance                  | RG                  | f=1MHz, open drain                             |                        | -    | 3.7   | -    | Ω    |

## Dynamic Ratings

| Parameter   | Symbol                 | Conditions   | min. | typ. | max. | Unit |
|---|------------------------|--|------|------|------|------|
| Forward Transconductance                                  | <b>g</b> <sub>fs</sub> | I <sub>D</sub> =10A<br>V <sub>DS</sub> =25V                  | 8    | 16   | -    | s    |
| Input Capacitance   | Ciss                   | V <sub>DS</sub> =400V  | -    | 1370 | -    |      |
| Output Capacitance  | Coss                   | V <sub>GS</sub> =0V  | -    | 40   | -    |      |
| Reverse Transfer Capacitance                              | Crss                   | f=250kHz   | -    | 3    | -    |      |
| Effective output capacitance,<br>energy related (Note *6) | C <sub>o(er)</sub>     | V <sub>GS</sub> =0V<br>V <sub>DS</sub> =0400V                | -    | 115  | -    | pF   |
| Effective output capacitance, time related (Note *7)      | C <sub>o(tr)</sub>     | V <sub>GS</sub> =0V<br>V <sub>DS</sub> =0400V<br>ID=constant | -    | 365  | -    |      |
| Turn-On Time  | t <sub>d(on)</sub>     |  | -    | 80   | -    |      |
| Turn-On Time  | tr                     | $V_{DD}$ =400V, $V_{GS}$ =10V                                | -    | 27   | -    | - ns |
| Turn Off Time   | t <sub>d(off)</sub>    | − I₀=10A, R₀=27Ω<br>_ See Fig.3 and Fig.4                    | -    | 124  | -    |      |
| Turn-Off Time   | tr                     |  | -    | 19   | -    |      |
| Total Gate Charge   | Q <sub>G</sub>         | V₀₀=400V, l₀=20A<br>V₀₅=10V<br>See Fig.5                     | -    | 52   | -    |      |
| Gate-Source Charge  | Q <sub>GS</sub>        |  | -    | 16   | -    |      |
| Gate-Drain Charge   | Q <sub>GD</sub>        |  | -    | 20.5 | -    | nC   |
| Drain-Source crossover Charge                             | Qsw                    |  | -    | 8.5  | -    | 1    |

Note \*6 :  $C_{o(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400V. Note \*7 :  $C_{o(tr)}$  is a fixed capacitance that gives the same charging times as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400V.

### Reverse Diode

| Parameter                     | Symbol          | Conditions  | min. | typ. | max. | Unit |
|-------------------------------|-----------------|---|------|------|------|------|
| Avalanche Capability          | lav             | L=6.02mH, T₀ =25°C<br>See Fig.1 and Fig.2                               | 6.6  | -    | -    | А    |
| Diode Forward On-Voltage      | V <sub>SD</sub> | I <sub>F</sub> =20A,V <sub>GS</sub> =0V<br>T <sub>ch</sub> =25°C        | -    | 1    | 1.35 | V    |
| Reverse Recovery Time         | trr             | - I⊧=20A, V₀₀=400V<br>-di/dt=100A/μs<br>T₅h=25°C<br>See Fig.6 and Fig.7 | -    | 150  | -    | ns   |
| Reverse Recovery Charge       | Qrr             |   | -    | 1    | -    | μC   |
| Peak Reverse Recovery Current | Irp             |   | -    | 13   | -    | А    |

## Thermal Resistance

| Parameter          | Symbol    | min. | typ. | max. | Unit |
|--------------------|-----------|------|------|------|------|
| Channel to Case    | Rth(ch-c) | -    | -    | 0.83 | °C/W |
| Channel to Ambient | Rth(ch-a) | -    | -    | 62   | °C/W |







VDS [V]







Fig.1 Avalanche Test circuit



Fig.2 Operating waveforms of Avalanche Test



Fig.3 Switching Test circuit



Fig.4 Operating waveform of Switching Test



Fig.5 Operating waveform of Gate charge Test





Fig.6 Reverse recovery Test circuit

Fig.7 Operating waveform of Reverse recovery Test

#### Outview: TO-220 Package



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